AN6041

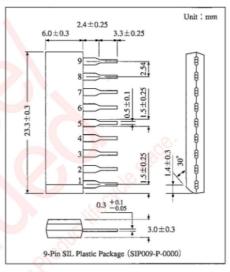
Dual Balanced Modulator IC for Video Camera

Overview

The AN6041 is an integrated circuit which incorporates two balanced modulators.

Features

- · Dual balanced modulator
- External bias circuit is not required
- · Carrier suppression: 40dB typ.

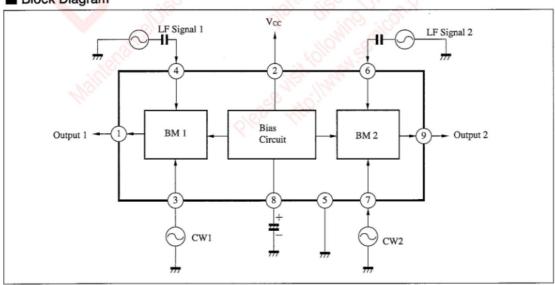


Pin Descriptions

Pin No.	Pin name		
1	Output (1)	0/5	
2	Vcc	100	
3	Carrier input (1)	01,1	
4	Signal input (1)	16/2	
5	GND	.16,	
6	Signal input (2)	9	
7	Carrier input (2)		
8	Ref. voltage		
9	Output (2)		

ICs for Video Camera

■ Block Diagram



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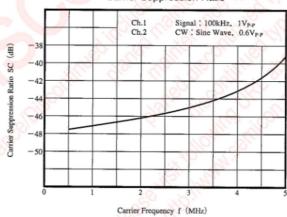
■ Absolute Maximum Ratings (Ta=25°C)

Parameter		ameter Symbol		Unit	
Supply voltage		Vcc	9.5	V	
Supply current		Icc	25	mA	
Power dissipation		P _D	240	mW	
Temperature	Operating ambient temperature	Topr	-20 to +75	υ ν	
	Storage temperature	T _{stg}	-55 to +125	70	

■ Electrical Characteristics (Ta=25°C)

Parameter	Symbol	Condition	min	typ	max	Unit
Circuit voltage	V ₁₋₅	V _{cc} =9V	5.7	6.3	6.9	V
	V ₃₋₅		1.9	2.4	2.9	V
	V ₄₋₅		5.5	6.1	6.7	V
	V ₆₋₅		5.5	6.1	6.7	V
	V ₇₋₅		1.9	2.4	2.9	V
	V ₈₋₅		5.5	6.1	6.7	V
	V ₉₋₅		5.5	6.0	6.7	V
Total circuit current	I _{tot}		13	17	22	mA
Carrier leak	CL (1)		~(O)		2.5	mV _{rms}
	CL (2)		< <u> </u>	_	2.5	mV _{rms}
Output voltage	V _{O(i)}		550	650	760	mV _{rms}
	V _{O(2)}		550	650	760	mV _{rms}

Carrier Suppression Ratio



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